

HMC470LP3 / 470LP3E

v04.1108





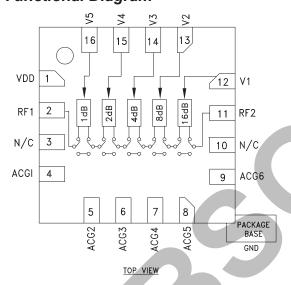
1 dB LSB GaAs MMIC 5-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3 GHz

Typical Applications

The HMC470LP3(E) is ideal for:

- Cellular; UMTS/3G Infrastructure
- ISM, MMDS, WLAN, WIMAX
- Microwave Radio & VSAT
- Test Equipment and Sensors

Functional Diagram



Features

1 dB LSB Steps to 31 dB
Single Control Line Per Bit
TTL/CMOS Compatible Control
± 0.3 dB Typical Step Error
Single +5V Supply
16 Lead 3x3mm SMT Package: 9mm²
Included in the HMC-DK004 Designer's Kit

General Description

The HMC470LP3(E) is a broadband 5-bit GaAs IC digital attenuators in low cost leadless surface mount packages. This single positive control line per bit digital attenuator incorporates off chip AC ground capacitors for near DC operation, making it suitable for a wide variety of RF and IF applications. Covering DC to 3 GHz, the insertion loss is less than 1.5 dB typical. The attenuator bit values are 1 (LSB), 2, 4, 8, and 16 dB for a total attenuation of 31 dB. Attenuation accuracy is excellent at \pm 0.3 dB typical step error with an IIP3 of +45 dBm. Five TTL/CMOS control inputs are used to select each attenuation state. A single Vdd bias of +5V is required.

Electrical Specifications,

 $T_A = +25^{\circ}$ C, With Vdd = +5V & VctI = 0/+5V (Unless Otherwise Noted)

| Parameter | | Frequency (GHz) | Min. | Тур. | Max. | Units |
|------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|------------------------------------------------|-------------------------------------------------------------------------------------------------------------------|-------------------|-------------------|----------------|
| Insertion Loss | | DC - 1.5 GHz 1.5 - 2.3 GHz 2.3 - 3.0 GHz | | 1.3 1.4 1.7 | 1.6 1.7 2.0 | dB dB dB |
| Attenuation Range | | DC - 3 GHz | | 31 | | dB |
| Return Loss (RF1 & RF2, All Atten. States) | | DC - 3 GHz | | 17 | | dB |
| Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States 1.0 - 15.0 dB States 16.0 - 31.0 dB States | | DC - 2.3 GHz 2.3 - 3.0 GHz 2.3 - 3.0 GHz | ± (0.3 + 2% of Atten. Setting) Max. ± (0.3 + 3% of Atten. Setting) Max. ± (0.3 + 6% of Atten. Setting) Max. | | dB dB dB | |
| Input Power for 0.1 dB Compression | | 0.1 - 3.0 GHz | | 20 | | dBm |
| Input Third Order Intercept Point (Two-Tone Input Power= 0 dBm Each Tone) | REF - 15 dB States 16 - 31 dB States | 0.1 - 3.0 GHz | | 45 35 | | dBm dBm |
| Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF) | | DC - 3 GHz | | 160 180 | | ns ns |

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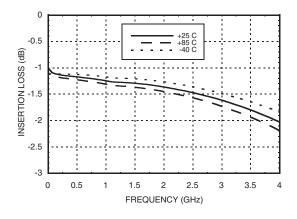


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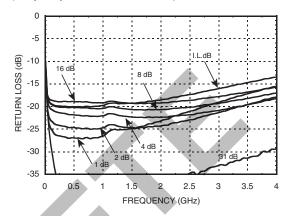
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Insertion Loss



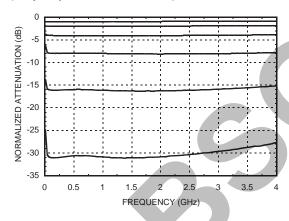
Return Loss RF1, RF2

(Only Major States are Shown)

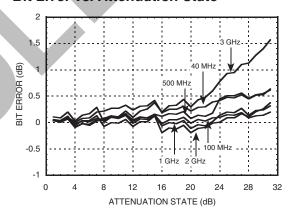


Normalized Attenuation

(Only Major States are Shown)

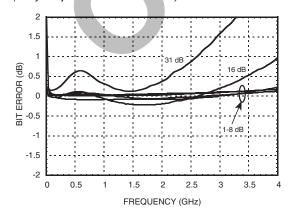


Bit Error vs. Attenuation State



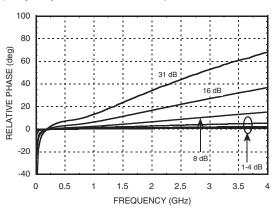
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)



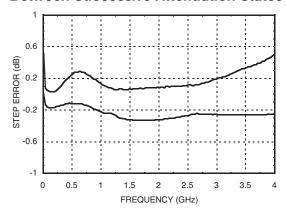


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Worst Case Step Error Between Successive Attenuation States



Bias Voltage & Current

| $Vdd = +5V \pm 10\%$ | | | | |
|----------------------|--------------------|--|--|--|
| Vdd (V) | Idd (Typ.) (mA) | | | |
| +4.5 | 4.0 | | | |
| +5.0 | 4.2 | | | |
| +5.5 | 4.4 | | | |

Control Voltage

| State | Bias Condition |
|-----------------|------------------------------|
| Low | 0 to +0.8V @ -5 uA Typ. |
| High | +2.0 to + 5 Vdc @ 40 uA Typ. |
| Note: Vdd = +5V | |

Truth Table

| | Attenuation | | | | | |
|-------------|-------------|------------|------------|------------|--------------------|--|
| V1 16 dB | V2 8 dB | V3 4 dB | V4 2 dB | V5 1 dB | State RF1 - RF2 | |
| High | High | High | High | High | Reference I.L. | |
| High | High | High | High | Low | 1 dB | |
| High | High | High | Low | High | 2 dB | |
| High | High | Low | High | High | 4 dB | |
| High | Low | High | High | High | 8 dB | |
| Low | High | High | High | High | 16 dB | |
| Low | Low | Low | Low | Low | 31 dB | |

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.



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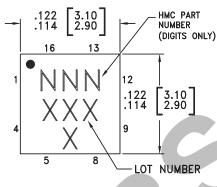
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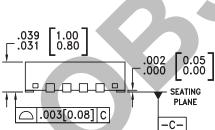
Absolute Maximum Ratings

| RF Input Power (DC - 3 GHz) | +27 dBm (T = +85 °C) |
|----------------------------------------------------------------|----------------------|
| Control Voltage Range (V1 to V5) | -1V to Vdd +1V |
| Bias Voltage (Vdd) | +7V |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T = 85 °C) (derate 7.7 mW/°C above 85 °C) | 0.5 W |
| Thermal Resistance | 130 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |

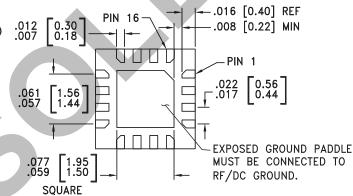


Outline Drawing





BOTTOM VIEW



NOTES

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking [3] |
|-------------|----------------------------------------------------|---------------|------------|---------------------|
| HMC470LP3 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 [1] | 470 XXXX |
| HMC470LP3E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2] | 470 XXXX |

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

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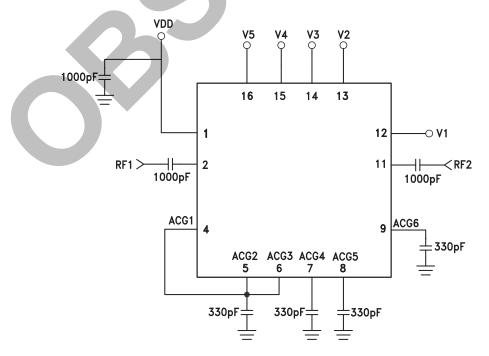
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Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------|---------------------|
| 1 | Vdd | Supply Voltage. | |
| 2, 11 | RF1, RF2 | This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. Select value based on lowest frequency of operation. | RF1, O |
| 3, 10 | N/C | These pins should be connected to PCB RF ground to maximize performance. | |
| 4 - 9 | ACG1 - ACG6 | External capacitor to ground is required. Select value for lowest frequency of operation. Place capacitor as close to pins as possible. | |
| 12 - 16 | V1 - V5 | See truth table and control voltage table. | V1-V5 142K 500 = |
| | GND | Package bottom has an exposed metal paddle that must also be connected to RF Ground. | ⊖ GND = |

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Application Circuit

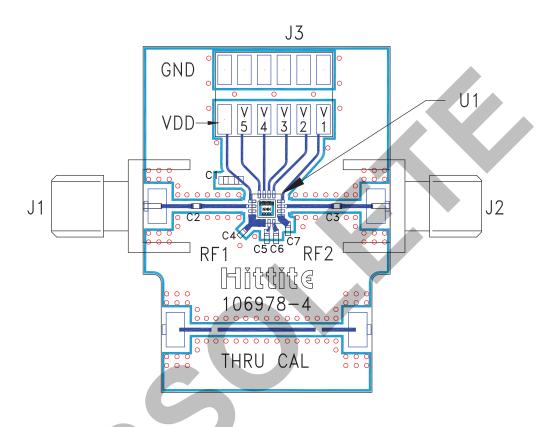






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Evaluation PCB



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List of Materials for Evaluation PCB 107006 [1]

| Item | Description | | |
|---------|----------------------------------------------|--|--|
| J1 - J2 | PC Mount SMA Connector | | |
| J3 | 12 Pin DC Connector | | |
| C1 | 1000 pF Capacitor, 0603 Pkg. | | |
| C2, C3 | 1000 pF Capacitor, 0402 Pkg. | | |
| C4 - C7 | 330 pF Capacitor, 0402 Pkg. | | |
| U1 | HMC470LP3 / HMC470LP3E Digital Attenuator | | |
| PCB [2] | 106978 Evaluation PCB | | |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350Re

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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<u>HMC470LP3E 107006-HMC470LP3 HMC470LP3 HMC470LP3ETR HMC470LP3TR HMC470LP3E-AN</u> HMC470LP3ETR-AN